

SKiM 450GD126DL



SKiM[®] 5

IGBT Modules

SKiM 450GD126DL

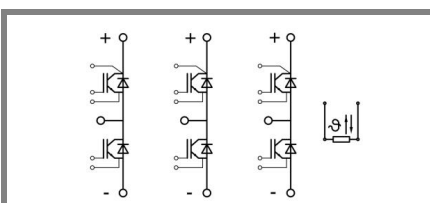
Target Data

Features

- Trench gate IGBT with field stop layer
- Low inductance case
- Fast & soft inverse CAL diodes
- Isolated by Al₂O₃ DCB (Direct Copper Bonded) ceramic plate
- Pressure contact technology for thermal contacts
- Spring contact system to attach driver PCB to the control terminals
- Integrated temperature sensor

Typical Applications*

- Uninterruptable power supplies (UPS)
- Three phase inverters for AC motor speed control

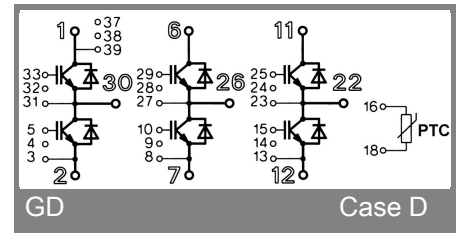
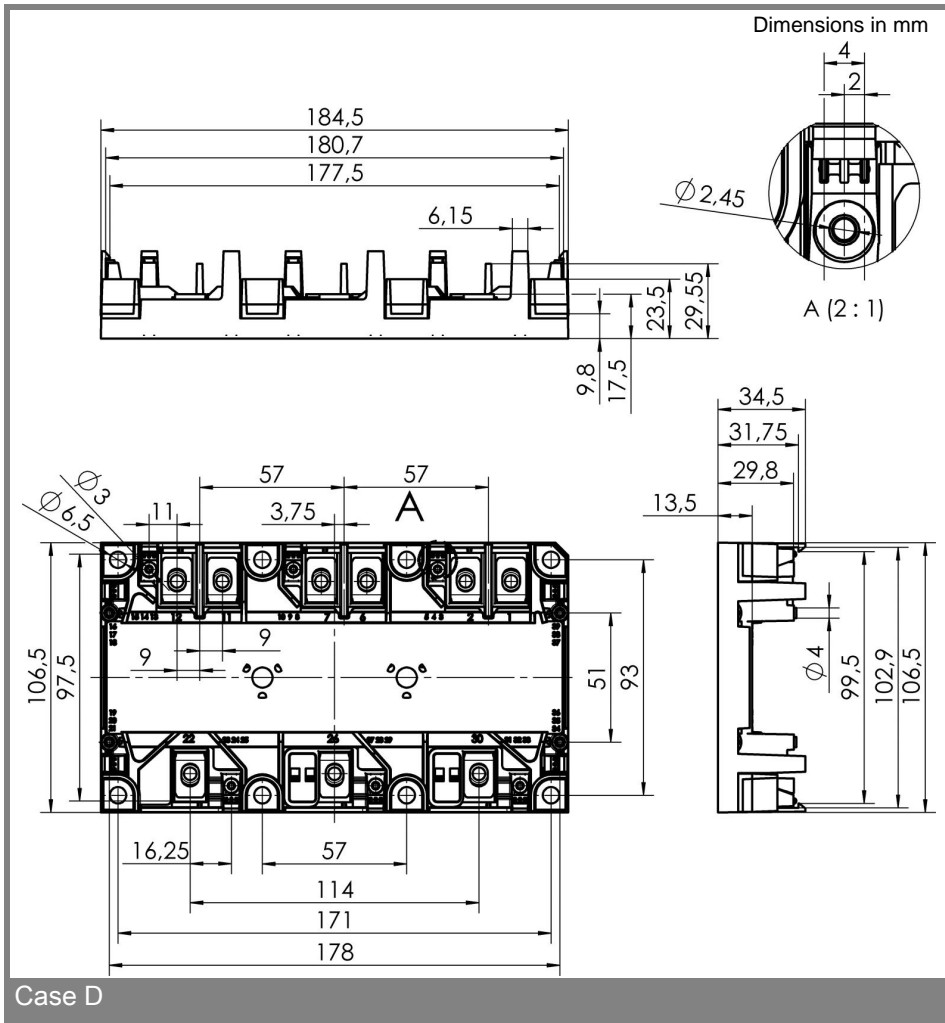


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Absolute Maximum Ratings		$T_c = 25\text{ }^\circ\text{C}$, unless otherwise specified	
Symbol	Conditions	Values	Units
IGBT			
V_{CES}		1200	V
I_C	$T_s = 25\text{ (70) }^\circ\text{C}$	390 (300)	A
I_{CRM}	$t_p = 1\text{ ms}$	780	A
V_{GES}		± 20	V
$T_j\text{ (}T_{stg}\text{)}$		- 40 ... + 150 (125)	$^\circ\text{C}$
T_{cop}	max. case operating temperature	125	$^\circ\text{C}$
V_{isol}	AC, 1 min.	2500	V
Inverse diode			
I_F	$T_s = 25\text{ (70) }^\circ\text{C}$	345 (260)	A
I_{FRM}	$t_p = 1\text{ ms}$	780	A
I_{FSM}	$t_p = 10\text{ ms}$; sin.; $T_j = 150\text{ }^\circ\text{C}$	3300	A

Characteristics		$T_c = 25\text{ }^\circ\text{C}$, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT					
$V_{GE(th)}$	$V_{GE} = V_{CE}$; $I_C = 18\text{ mA}$	4,95	5,8	6,55	V
I_{CES}	$V_{GE} = 0$; $V_{CE} = V_{CES}$; $T_j = 25\text{ }^\circ\text{C}$			0,6	mA
V_{CEO}	$T_j = 25\text{ (125) }^\circ\text{C}$		1 (0,9)	1,2 (1,1)	V
r_{CE}	$T_j = 25\text{ (125) }^\circ\text{C}$		1,6 (2,4)	2,1 (3)	m Ω
V_{CEsat}	$I_{Cnom} = 450\text{ A}$; $V_{GE} = 15\text{ V}$; $T_j = 25\text{ (125) }^\circ\text{C}$ on chip level		1,7 (2)	2,15 (2,45)	V
C_{ies}	$V_{GE} = 0$; $V_{CE} = 25\text{ V}$; $f = 1\text{ MHz}$		35		nF
C_{oes}	$V_{GE} = 0$; $V_{CE} = 25\text{ V}$; $f = 1\text{ MHz}$		2,5		nF
C_{res}	$V_{GE} = 0$; $V_{CE} = 25\text{ V}$; $f = 1\text{ MHz}$		2,4		nF
L_{CE}				20	nH
$R_{CC'+EE'}$	resistance, terminal-chip $T_c = 25\text{ (125) }^\circ\text{C}$		0,9 (1,1)		m Ω
$t_{d(on)}$	$V_{CC} = 600\text{ V}$		210		ns
t_r	$I_{Cnom} = 450\text{ A}$		35		ns
$t_{d(off)}$	$R_{Gon} = R_{Goff} = 1\text{ }^\circ\Omega$		680		ns
t_f	$T_j = 125\text{ }^\circ\text{C}$		90		ns
$E_{on}\text{ (}E_{off}\text{)}$	$V_{GE} \pm 15\text{ V}$		39 (54)		mJ
$E_{on}\text{ (}E_{off}\text{)}$	with SKHI 65; $T_j = 125\text{ }^\circ\text{C}$ $V_{CC} = 600\text{ V}$; $I_C = 450\text{ A}$				mJ
Inverse diode					
$V_F = V_{EC}$	$I_{Fnom} = 300\text{ A}$; $V_{GE} = 0\text{ V}$; $T_j = 25\text{ (125) }^\circ\text{C}$		2 (1,8)	2,55 (2,3)	V
V_{TO}	$T_j = 25\text{ (125) }^\circ\text{C}$		1,1	1,45 (1,25)	V
r_T	$T_j = 25\text{ (125) }^\circ\text{C}$		3	3,5 (3,5)	m Ω
I_{RRM}	$I_F = 450\text{ A}$; $T_j = 125\text{ }^\circ\text{C}$		500		A
Q_{rr}	$V_{GE} = V\text{ di/dt} = 8200\text{ A}/\mu\text{s}$		62		μC
E_{rr}	$R_{Gon} = R_{Goff} = 1\text{ }^\circ\Omega$		30		mJ
Thermal characteristics					
$R_{th(j-s)}$	per IGBT			0,13	K/W
$R_{th(j-s)}$	per FWD			0,19	K/W
Temperature Sensor					
R_{TS}	$T = 25\text{ (100) }^\circ\text{C}$		1 (1,67)		k Ω
tolerance	$T = 25\text{ (100) }^\circ\text{C}$		3 (2)		%
Mechanical data					
M_1	to heatsink (M5)	2		3	Nm
M_2	for terminals (M6)	4		5	Nm
w				460	g

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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.